

SML-Z14x/ZN4x Series

Data Sheet

■ Features

- High brightness
- 20/50mA guaranteed specifications
- PLCC2 package

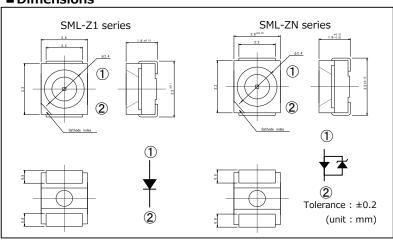


■ Size

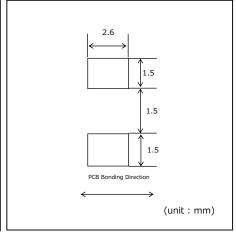
3528 (1411) 3.5 × 2.8mm (t=1.9mm)



■ Dimensions



■ Recommended Solder Pattern



■ Moisture sensitivity level(MSL): Level 3

■ Specifications

				Abso	olute Ma	kimum R	tatings (Ta=25	°C)			Electri	ical and	d Optica	l Char	acteristi	cs (Ta=	25°C)		
Part No.	Chip Structure	Emitting	Power	Forward	Peak Forward	Reverse		Storage Temp.	Forward '	Voltage V _F	Reverse (Current I _R			aveleng coordinat		Lumine	ous Inte	nsity I _v
		Color	Dissipation	Current	Current	Voltage			Тур.	IF	Max.	V_R	Min.*2	Тур.	Max.*2	IF	Min.	Тур.	IF
			P _D (mW)	I _F (mA)	I _{FP} (mA)	$V_R(V)$	T _{opr} (°C)	T _{stg} (°C)	(V)	(mA)	(μΑ)	(V)	(nm)	(nm)	(nm)	(mA)	(mcd)	(mcd)	(mA)
SML-Z14VT(A)		Red											625	630	635		56	112	
SML-Z14UT(A)		Keu	168						1.9				615	620	625		112	224	
SML-Z14DT(A)		Orange											602	605	608		140	280	
SML-Z14YT(A)		Yellow								20			586	589	592	20	140	200	20
SML-Z14MT(A)		Yellowish Green	175						2.0				568	571	574	'	45	90	
SML-Z14FT(A)		0							2.0				561.5	564	566.5	'	22.4	45	
SML-Z14PT(A)	AIG-I-D	Green		70	000+1	40						40	557	560	563	'	11.2	22.4	
SML-Z14V4T	AlGaInP	D. J		70	200*1	12	40 400				40	12	-	630	-		140	280	
SML-Z14U4T		Red					-40 ~ +100		2.0		10		-	620	-	'	280	560	
SML-Z14D4T		Orange						-40 ~ +100					-	605	-	,	055	710	
SML-Z14Y4T		Yellow	189							50			587	590	593	50	355	710	50
SML-Z14M4T		Yellowish Green							0.4				569	572	575	'	112	224	
SML-Z14F4T									2.1				-	565	-	,	56	120	
SML-Z14P4T		Green											-	561	-	'	22.4	56	
SMLZ14EGT(A)		Green	120			-			3.4			-	519	528	536		710	1100	
SMLZ14BGT(A)		Divi		00	1	5				00		5	464	470	476	00	140	280	00
SMLZN4BGT(A)	InGaN	Blue	114	30	100* ¹				3.3	20			464	470	476	20	140	300	20
SMLZN4WBGUW(A) *3		White				_	-40 ~ +85				-	-	(x, y)	(0.30,	0.28)	•	1800	2400	

^{*1:1/10,1}kHz *2: Measurement tolerance:±1nm、*3:Brightness for white color is noted with chromaticity coordinate(x,y).

Electrical Characteristics Curves

Reference

Fig.1 Forward Current

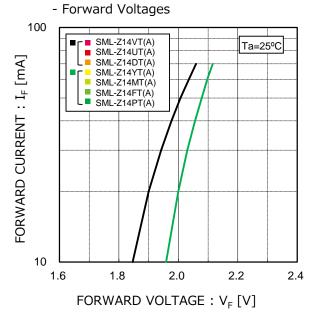
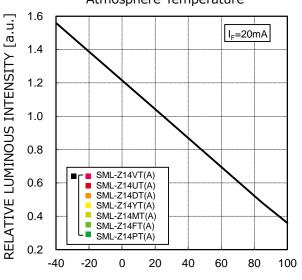
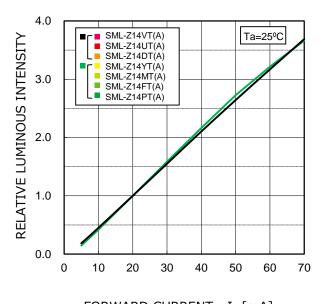


Fig.2 Luminous Intensity -Atmosphere Temperature



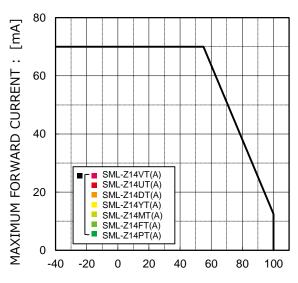
ATMOSPHERE TEMPERATURE: Ta [°C]

Fig.3 Luminous Intensity - Forward Current



FORWARD CURRENT : I_F [mA]

Fig.4 Derating



AMBIENT TEMPERATURE: Ta [°C]

■ Electrical Characteristics Curves

Reference

Fig.1 Forward Current
- Forward Voltages

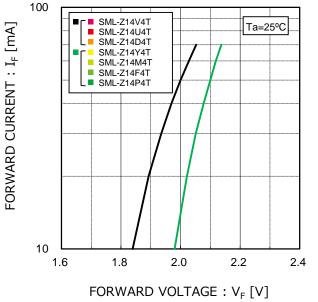
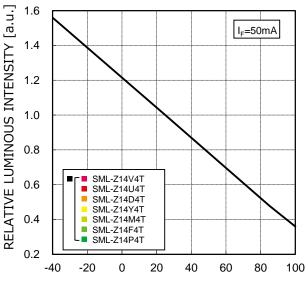


Fig.2 Luminous Intensity - Atmosphere Temperature



ATMOSPHERE TEMPERATURE: Ta [°C]

Fig.3 Luminous Intensity - Forward Current

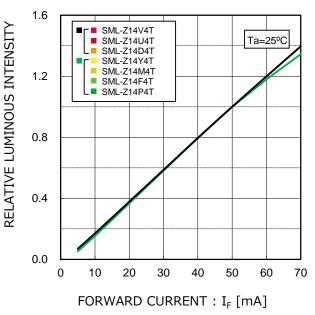
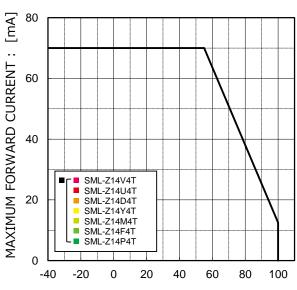


Fig.4 Derating



AMBIENT TEMPERATURE: Ta [°C]

■ Electrical Characteristics Curves

Reference

Fig.1 Forward Current

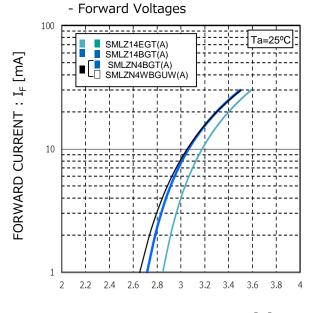
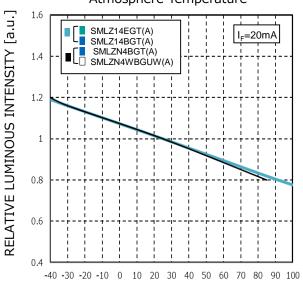


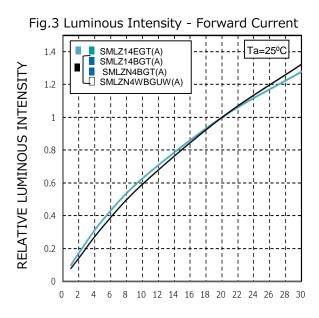
Fig.2 Luminous Intensity - Atmosphere Temperature



FORWARD VOLTAGE: V_F [V]

ATMOSPHERE TEMPERATURE : Ta [°C]

Fig.4 Derating



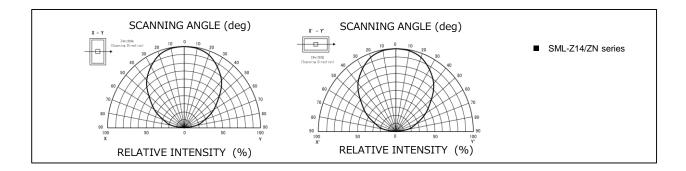
FORWARD CURRENT : I_F [mA]

AMBIENT TEMPERATURE: Ta [°C]

-40 -30 -20 -10 0 10 20 30 40 50 60 70 80 90 100 110

■ Viewing Angle

Reference



■ Rank Reference of Brightness*

*Measurement tolerance: ±10%

Red(V,U)																(Ta	=25°C, I _F	=20mA)
Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14VT(A)																		
SML-Z14UT(A)																		
																(Ta	=25°C, I _F	=50mA)

Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14V4T																		
SML-Z14U4T																		

Orange(D) (Ta=25°C, I_F=20mA)

	,																	
Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	ΑZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14DT(A)																		
																(Ta	=25°C, I _F	=50mA)

Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14D4T																		

Yellow(Y) (Ta=25°C, I_F=20mA)

_																			
	Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
	lv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
S	SML-Z14YT(A)																		
_																	(Ta	=25°C, I _F	=50mA)
Г	Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	ΑZ	BA	BB	BC	BD	BE

Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	ΑZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14Y4T																		

Yellowish Green/Green(M,P,F)

(Ta=25°C, I_F =20mA)

Rank	AG	AH	AJ	AK	AL	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ
Iv (mcd)	9~11.2	11.2~14	14~18	18~22.4	22.4~ 28	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560
SML-Z14MT(A)																		
SML-Z14PT(A)																		
SML-Z14FT(A)																		
																(Ta	=25°C, I _F	=50mA)

Rank	AG	AH	AJ	AK	AL	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ
Iv (mcd)	9~11.2	11.2~14	14~18	18~22.4	22.4~ 28	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560
SML-Z14M4T																		
SML-Z14P4T																		
SML-Z14F4T																		

Rank	S1	S2	T1	T2	U1	U2	V1	V2	W1	W2	X1	X2	Y1	Y2	Z1	Z2
Iv (mcd)	90~110	110~140	140~180	180~220	220~280	280~360	360~450	450~560	560~710	710~900	900~1100	1100~1400	1400~1800	1800~2200	2200~2800	2800~3600
SMLZ14EGT(A)																

Blue(B) $(Ta=25^{\circ}C, I_F=20mA)$

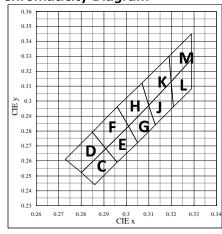
Rank	S1	S2	T1	T2	U1	U2	V1	V2	W1	W2	X1	X2	Y1	Y2	Z1	Z2
Iv (mcd)	90~110	110~140	140~180	180~220	220~280	280~360	360~450	450~560	560~710	710~900	900~1100	1100~1400	1400~1800	1800~2200	2200~2800	2800~3600
SMLZ14BGT(A)																
SMLZN4BGT(A)																

 $White (WB) \tag{Ta=25°C, I_F=20mA)}$

Rank	S1	S2	T1	T2	U1	U2	V1	V2	W1	W2	X1	X2	Y1	Y2	Z1	Z2	Z3
Iv (mcd)	90~110	110~140	140~180	180~220	220~280	280~360	360~450	450~560	560~710	710~900	900~1100	1100~1400	1400~1800	1800~2200	2200~2800	2800~3600	3600~4500
SMLZN4WBGUW(A)																	

^{*}Please note that the brightness of some products may fall between ranks (half rank).

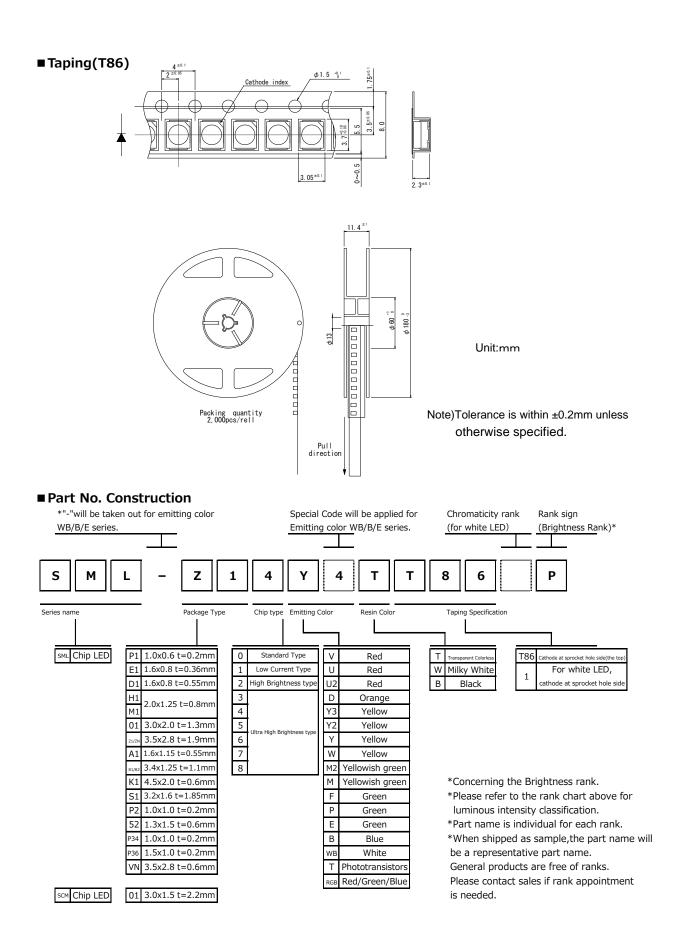
■ Chromaticity Diagram



				(T	a = 2	25℃	、If=	20m	A)
(()	D		E		F		G	
Χ	У	Χ	У	Χ	У	Χ	У	Χ	У
0.296	0.259	0.291	0.268	0.296	0.259	0.291	0.268	0.305	0.272
0.291	0.268	0.285	0.279	0.291	0.268	0.285	0.279	0.301	0.283
0.280	0.252	0.273	0.261	0.301	0.283	0.296	0.296	0.310	0.297
0.286	0.244	0.280	0.252	0.305	0.272	0.301	0.283	0.313	0.284
ŀ	1]	ŀ	(l		١	1
X	У	X) y	X	У	X	у	X	1 y
X 0.301	y 0.283	X 0.310	y 0.297		У	X 0.320	y 0.313		y 0.330
	y 0.283 0.296		y 0.297 0.313	Х	y 0.312		y 0.313 0.328	Х	У
0.301		0.310		X 0.307	y 0.312 0.330	0.320		X 0.319	y 0.330
0.301 0.296	0.296	0.310	0.313	X 0.307 0.319 0.320	y 0.312 0.330 0.313	0.320 0.329 0.329	0.328	X 0.319 0.329	y 0.330 0.345

Measurement tolerance : ± 0.01

[SML-Z14x/ZN4x series] [Data Sheet]



■ Packing Specification

Complying with IPC/JEDEC J-STD-033.

■ Precaution (Surface Mount Device)

1. Storage

If the product is heated during the reflow under the condition of hygroscopic state, it may vaporize and expand which will influence the performance of the product. Therefore, the package is waterproof. Please use the product following the conditions:

Using Conditions

Classification	Temperature	Humidity	Expiration Date	Remark	
①Before	5~30℃	30~70%RH	Within 1 year	Storage with waterproof package	
using	3, 030 C	30, 970 70 KII	from Receiving	Storage with waterproof package	
②After opening	5~30℃	Below 70%RH	Within 168h	Please storing in the airtight container	
package	3. 30 C	Delow 7070KII	WIGHT 100H	with our desiccant (silica gel)	

Baking

Bake the product in case of below:

- ①The expiration date is passed.
- ②The color of 5% and 10% on humidity indicator card is not green.

(Even if the product is before expiration date.)

Baking Conditions

Tempera	Temperature		Humidity
60±3°	Č	40∼48h	Below 20%RH
Remark	•Reel and so please	oducts in reel. embossed tape try not to apply end bake once.	are easy to be deformed when baking, stress on it.

2. Application Methods

2 - 1. Precaution for Drive System and Off Mode

Design the circuit without the electric load exceeding the ABSOLUTE MAXIMUM RATING that applies on the products. If drive by constant voltage, it may cause current deviation of the LED and result in deviation of luminous intensity, so we recommend to drive by constant current. (Deviation of VF Value will cause deviation of current in LED.) Furthermore, for off mode, please do not apply voltage neither forward nor reverse. Especially, for the products with the Ag-paste used in the die bonding, there's high possibility to cause electro migration and result in function failure.

2 - 2. About Derating

It is considered that derating characteristics will not result in LED chip's electrical destruction. Even within the derating, the reliability and luminous life can be affected depending on operating conditions and ambient environment. So we would be appreciate it if you can confirm with your application again.

2 - 3. About product life

Depending on operating conditions and environment(applied current, ambient temperature and humidity, corrosive gas), decreasing of luminosity and change of chromaticity may occur even within the specification conditions.

Please contact our sales office if you use it for the following applications.

①It requires long luminosity life

②It is always lit

2 – 4. Applied Stress on Product

The top of the LED is very soft, which the silicon resin is used as sealing resin.

Therefore, please pay attention to the overstress on it which may influence its reliability.

2 - 5. Usage

The Product is LED. We are not responsible for the usage as the diode such as Protection Chip, Rectifier, Switching and so on.

3. Others

3 – 1. Surrounding Gas

Notice that if it is stored under the condition of acid gas (chlorine gas, sulfured gas) or alkali gas (ammonia), it may result in low soldering ability (caused by the change in quality of the plating surface) or optical characteristics changes (light intensity, chrominance) and change in quality of cause die bonding (Ag-paste) materials. All of the above will function failure of the products.

Therefore, please pay attention to the storage environment for mounted product (concern the generated gas of the surrounding parts of the products and the atmospheric environment).

3 – 2. Electrostatic Damage

The product is part of semiconductor and electrostatic sensitive, there's high possibility to be damaged by the electrostatic discharge. Please take appropriate measures to avoid the static electricity from human body and earthing of production equipment. Especially, InGaN type LEDs have lower resistance value of electrostatic discharge and it is recommended to introduce the ESD protection circuit. The resistance values of electrostatic discharge (actual values) vary with products, therefore, please call our Sales staffs for inquiries.

3 – 3. Electromagnetic Wave

Applications with strong electromagnetic wave such as, IH cooker, will influence the reliability of LED, therefore please evaluate before using it.

4. Mounting

4 - 1. Soldering

- •No resin hardening agent such as filler is used in the sealing resin of the product. Therefore, resin expansion and moisture absorption at humidity will cause heat stress during soldering process and finally has bad influence on the product's reliability.
- •The product is not guaranteed for flow soldering.
- •Do not expose the product in the environment of high temperature (over 100° C) or rapid temperature shift (within 3° C/sec. of temperature gradient) during the flow soldering of surrounding parts. In case of carrying out flow soldering of surrounding parts without recommended conditions, please contact us for inquiries.
- ·Please set appropriate reflow temperature based on our product usage conditions and specification.
- •The max for reflowing is 2 times, please finish the second reflow soldering and flow soldering with other parts within the usage limitation after open the moistureproof package.
- •Compare with N2 reflow, during air reflow, because of the heat and surrounding conditions, it may cause the discoloration of the resin.
- •For our product that has no solder resist, because of its solder amount and soldering conditions, one of its specific characteristics is that solder will penetrate into LED. Thus, there's high possibility that will influence its reliability. Therefore, please be informed, concerning it before using it.

4 – 2. Automatic Mounting

4-2-1. Suction nozzle

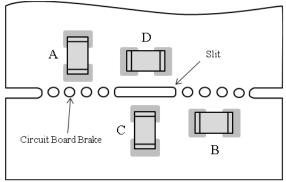
Excessive load may cause damage inside the LED product, so select an optimal suction nozzle according to the material and shape of the LED product.

4-2-2. Mini Package (Smaller than 1608 size)

•Vibration may result in low mounting rate since it will cause the static electricity of product and adhere to top cover tape. Therefore, the magnet should be set on parts feeder cassette of the mounter to control the product stabilization. In addition, it is recommended to set ionizer to prevent electrostatic charge.

4 - 3. Mounting Location

The stress like bending stress of circuit board dividing after mounting, may cause LED package crack or damage of LED internal junction, therefore, please concern the mounting direction and position to avoid bending or screwing with great stress of the circuit board.



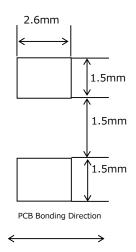
Stress strength according to he mounting position: A>B>C>D

4-4. Mechanical Stress after Mounting

The mechanical stress may damage the LED after Circuit Mounting, so please pay attention to the touch on product.

4 – 5. Soldering Pattern for Recommendation

We recommend the soldering pattern that shows on the right. It will be different according to mounting situation of circuit board, therefore, please concern before designing.

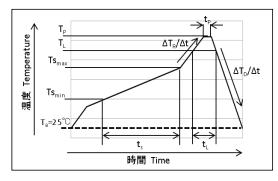


4 - 6. Reflow Profile

For reflow profile, please refer to the conditions below:(%)

■ Meaning of marks, Conditions

= rearing or marks, conditions				
Mark	Meanings	Conditions		
Ts _{max}	Maximum of pre-heating temperature	180℃		
Ts _{min}	Minimum of pre-heating temperature	140℃		
t _s	Time from Tsmin to Tsmax	Over 60sec.		
T_L	Reference temperature	230~250℃		
t∟	Retention time for TL	Within 40sec.		
T _P	Peak temperature	250℃(Max)		
t _P	Time for peak temperature	Within 10sec.		
$\Delta T_R/\Delta t$	Temperature rising rate	Under 3℃/sec.		
ΔT _D /Δt	Temperature decreasing rate	Over -3℃/sec.		



*Above conditions are for reference. Therefore, evaluate by customer's own circuit boards and reflow furnaces before using, because stress from circuit boards and temperature variations of reflow furnaces vary by customer's own conditions.

4 – 7. Attention Points in Soldering Operation

This product was developed as a surface mount LED especially suitable for reflow soldering. So reflow soldering is recommended. In case of implementing manual soldering, please take care of following points.

1SOLDER USED

Sn-Cu, Sn-Ag-Cu, Sn-Ag-Bi-Cu

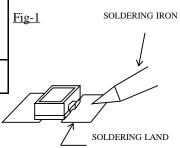
2HAND SOLDERING CONDITION

LED products do not contain reinforcement material such as a glass fillers.

So thermal stress by soldering greatly influence its reliability.

Please keep following points for manual soldering.

	ITEM	RECOMMENDED CONDITION
a)	Heating method	Condition) Temp. of iron top less than 325℃ within 3 sec. Heating on PCB pattern, not direct to the LED. (Fig-1)
b)		Please handle after the part temp. goes down to room temp.



4 - 8. Cleaning after Soldering

Please follow the conditions below if the cleaning is necessary after soldering.

Solvent	We recommend to use alcohols solvent such as, isopropyl alcohols
Temperature	Under 30℃ within 3 minutes
Ultrasonic Cleaning	15W/Below 1 liter (capacity of tank)
Drying	Under 100℃ within 3 minutes

Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications.
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communication, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.
- 7) The Products specified in this document are not designed to be radiation tolerant.
- 8) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
- Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 10) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
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